

#### 12500 TI Boulevard, MS 8640, Dallas, Texas 75243

# PCN#20150219001 Qualification of TI Mexico as a new Assembly and Test site for select PIP Module Devices Change Notification / Sample Request

**Date:** 2/24/2015

To: Newark/Farnell PCN

#### Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

We request you acknowledge receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance of the change. If you require samples or additional data to support your evaluation, please request within 30 days.

The changes discussed within this PCN will not take effect any earlier than **90** days from the date of this notification, unless customer agreement has been reached on an earlier implementation of the change. This notification period is per TI's standard process.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN\_ww\_admin\_team@list.ti.com).

Sincerely,

PCN Team SC Business Services

### 20150219001 Attachment: 1

### **Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

**DEVICE** PTR08060WVD PTR08100WVD **CUSTOMER PART NUMBER** 

null null

Technical details of this Product Change follow on the next page(s).

PCN Number:		20150219001						PCN	Date:	2/24/2015	
Title: Qualification of					of TI Mexico as a new Assembly and Test site for select PIP Module Devices						
<b>Customer Contact:</b>			PCN Manager			Dept:	Quality Services				
Proposed 1 <sup>st</sup> Ship Da			te: 05/24/2015			Estimated Sample Availab			ailability:	ty: Provided upon Request	
Cha	ange	Туре:									
$\boxtimes$	Asse	mbly Site		Assembly Process			Assembly Materials				
	Desi	gn			Electrical Specification			Mechanic	al Specif	ication	
	Test				Packing/Shipping/Labeling Te				Test Proc	ess	
	Wafer Bump Site Wafer Bur			Wafer Bur				Wafer Bump Process			
	Wafer Fab Site				Wafer Fab Materials V				Wafer Fab Process		
				Part number change							
						PCN De	etails				
Description of Change:											
Texas Instruments is pleased to announce the qualification of TI Mexico as a new Assembly and test site for the list of PIP devices shown below. There are no differences in the package construction as a result of this change.  Test coverage, insertions, conditions will remain consistent with current testing and verified with test MQ.											
Reason for Change:											
Continuity of Supply											
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):											
ıoN	None										

## Changes to product identification resulting from this PCN: Assembly Site

Hana Thailand Assembly Site Origin (22L) ASO: HNT

TI Mexico Assembly Site Origin (22L) ASO: PTM

Sample product shipping label (not actual product label)





(1P) \$N74L\$07N\$R (Q) 2000 (D) 0336 (31T)LOT: 3959047MLA (4W) TKY(1T) 7523483\$I2 (P) (2P) REV: (V) 0033317 (20L) CSO: SHE (21L) CCO:USA (22L) ASO: MLA (23L) ACO: MYS

**Topside Device marking:** 

Assembly site code for HNT= H
Assembly site code for MEX= V

Product Affected							
PTR08060WVC	PTR08060WVD	PTR08100WVC	PTR08100WVD				

Qualification Data: Approved February 2014						
This qualification has been specifically developed for the validation of this change. The qualification data						
validates that the proposed chang	validates that the proposed change meets the applicable released technical specifications.					
Qualification Device: PTR08100WVD						
Package Construction Details						
Assembly Si	te: FMX A/T		Lead Finish:		Matte Sn	
# Pins-Designator, Fami	ly:	5-EDN, SIP MODULE				
Qualification:  Plan  Test Results						
Reliability Test		Conditions	Sample Size/Fail			
		Conditions	Lot#1	Lot#2		
Biased Power Cycled Life		6.6C Case Temp, 1000 H	40/0			
Biased Humidity	85C/85%RH, 1000 Hrs			40/0		
Vibration	MIL-STD-883D, 2007.2			9/0	9/0	
Mechanical Shock	MIL-STD-883D, 2007.3			3/0	3/0	

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com